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## **CERMET GOLD CONDUCTOR**

8835-1D

ESL 8835-1D is a mixed-bonded gold conductor specially formulated for use on aluminium nitride substrates, exhibiting good conductivity and adhesion. The paste can also be used for dotting applications.

## **PASTE DATA**

Rheology: Thixotropic, screen-printable paste

Viscosity:

(Brookfield RVT, 10rpm,

ABZ spindle,  $25.5 \pm 0.5$  °C) 225 ± 25 Pa.s

Bonding Mechanism: Mixed-bonded

Shelf Life (20 - 25 °C): 6 months

**PROCESSING** 

Screen Mesh, Emulsion: 325 S/S, 25 µm

Levelling Time (at 20°C): 5 - 10 min

**Drying Time (at 125°C):** 10 -15 min

Firing Temperature Range: 850 - 1000 °C in air

Optimum: 850 °C Time at peak: 10 - 12 min

Rate of Ascent/Descent: 60 - 100 °C / min

Substrate for Calibration: AIN

Thinner: ESL 431 or 429

ESL Europe 8835-1D 9011-A

## **TYPICAL PROPERTIES**

**Fired Thickness:** 

(measured AIN)  $9.0 \pm 1.0 \,\mu m$ 

**Approximate Coverage:** 70 - 90 cm<sup>2</sup>/g

Resistivity:

(measured on a 100 mm x 0.25 mm conductor track) <4 m $\Omega$ / $\Box$ 

**Printing Resolution:** 

(line/space) 0.125 mm / 0.125 mm

Adhesion:

(90° pull, 2 mm x 2 mm pads, 80Au/20Sn and 62Sn/36Pb/2Ag)

Initial pull strength: 2.5 - 3.5 kg

**Thermosonic Au Wire Bond:** 

(25 µm wire; bond length 1 mm; 100% wire breaks)

8 - 12 g